

# **DRD520T14**

## **Rectifier Diode**

DS5990-1 March 2011 (LN28176)

### **FEATURES**

- Double Side Cooling
- High Surge Capability

### **KEY PARAMETERS**

$V_{RRM}$	1400V
I <sub>F(AV)</sub>	520A
I <sub>FSM</sub>	5900A

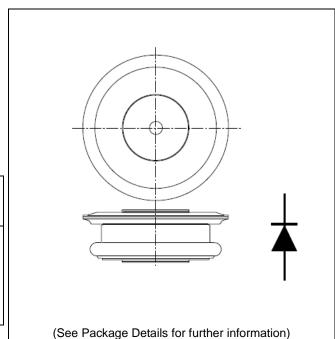


Fig. 1 Package outline

## **VOLTAGE RATINGS**

Part and Ordering Number	Repetitive Peak Voltages V <sub>RRM</sub> V	Conditions
DRD520T14 DRD520T12 DRD520T10 DRD520T08 DRD520T06	1400 1200 1000 800 600	$V_{RSM} = V_{RRM} + 100V$

### **ORDERING INFORMATION**

When ordering, select the required part number shown in the Voltage Ratings selection table.

For example:

**DRD520T14** for a 1400V device



## **CURRENT RATINGS**

### $T_{case} = 75$ °C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units		
Double Si	Double Side Cooled					
I <sub>F(AV)</sub>	Mean forward current	Half wave resistive load	620	А		
I <sub>F(RMS)</sub>	RMS value	-	970	Α		
I <sub>F</sub>	Continuous (direct) on-state current	-	880	Α		

## T<sub>case</sub> = 100°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units		
Double Si	Double Side Cooled					
I <sub>F(AV)</sub>	Mean forward current	Half wave resistive load	520	Α		
I <sub>F(RMS)</sub>	RMS value	-	820	Α		
l <sub>F</sub>	Continuous (direct) on-state current	-	740	А		

## **SURGE RATINGS**

Symbol	Parameter	Test Conditions	Max.	Units
I <sub>FSM</sub>	Surge (non-repetitive) on-state current	10ms half sine, T <sub>case</sub> = 190°C	5.9	kA
l <sup>2</sup> t	I <sup>2</sup> t for fusing	$V_R = 0$	0.17	MA <sup>2</sup> s



## THERMAL AND MECHANICAL RATINGS

Symbol	Parameter	Test Conditions	6	Min.	Max.	Units
R <sub>th(j-c)</sub>	Thermal resistance – junction to case	Double side cooled	DC	-	0.08	°C/W
R <sub>th(c-h)</sub>	Thermal resistance – case to heatsink	Double side cooled	DC	-	0.02	°C/W
T <sub>vj</sub>	Virtual junction temperature	Blocking V <sub>DRM</sub> / <sub>VRRM</sub>		-40	190	°C
T <sub>stg</sub>	Storage temperature range			-40	190	°C
F <sub>m</sub>	Clamping force			4	6	kN

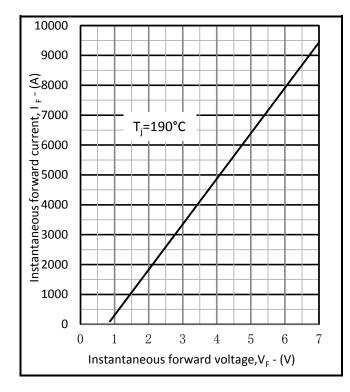
## **CHARACTERISTICS**

Symbol	Parameter	Test Conditions	Min.	Max.	Units
V <sub>FM</sub>	Forward voltage	At 800A peak, T <sub>case</sub> = 25°C	-	1.45	V
I <sub>RM</sub>	Peak reverse current	At V <sub>DRM</sub> , T <sub>case</sub> = 190°C	-	30	mA
Q <sub>S</sub>	Total stored charge	$I_F = 1000A$ , $dI_{RR}/dt = 10A/\mu s$	-	1500	μC
		$T_{case} = 190^{\circ}C, V_{R} = 100V$			
$V_{TO}$	Threshold voltage	At T <sub>vj</sub> = 190°C	-	0.8	٧
r <sub>T</sub>	Slope resistance	At T <sub>vj</sub> = 190°C	-	0.657	mΩ

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### **CURVES**



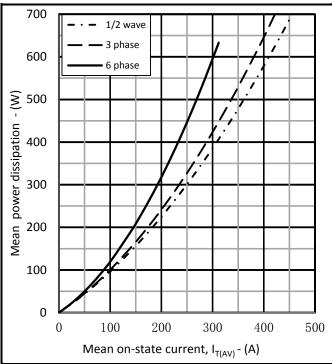
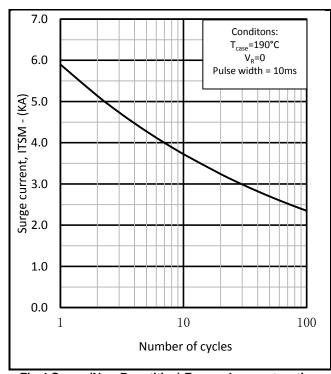
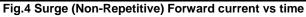


Fig.2 Maximum forward characteristics

Fig.3 Dissipation curves





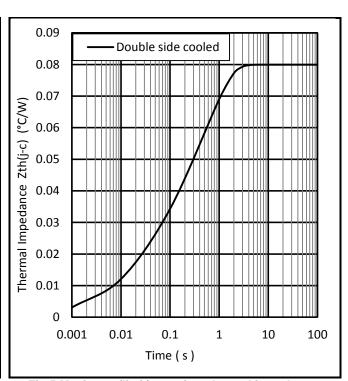
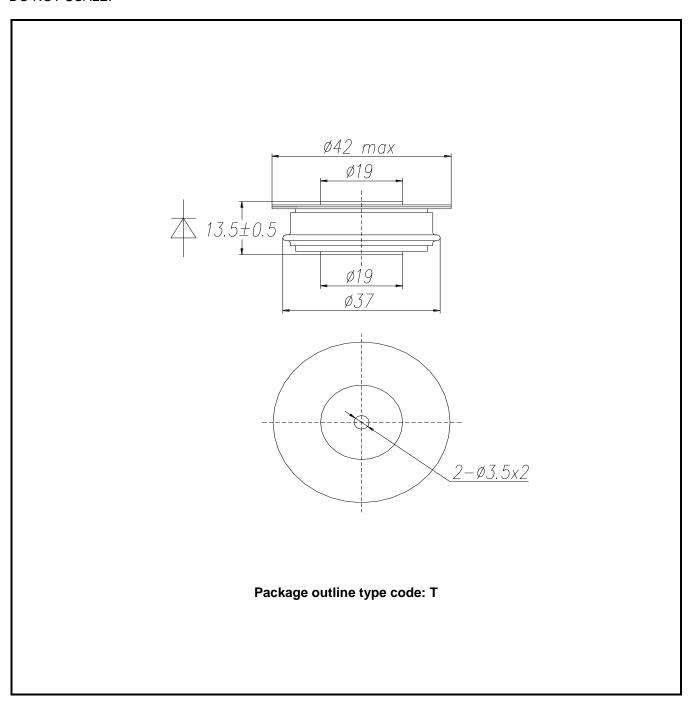


Fig.5 Maximum (limit) transient thermal impedancejunction to case



## **PACKAGE DETAILS**

For further package information, please contact Customer Services. All dimensions in mm, unless stated otherwise. DO NOT SCALE.



### Note:

Some packages may be supplied with gate and or tags.

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